

## PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT																		
NATURE OF CONVEYANCE:	Confirmatory Assignment																		
CONVEYING PARTY DATA																			
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<table border="1"> <tr> <td>Name:</td> <td>NXP B.V.</td> </tr> <tr> <td>Street Address:</td> <td>High Tech Campus 60</td> </tr> <tr> <td>City:</td> <td>Eindhoven</td> </tr> <tr> <td>State/Country:</td> <td>NETHERLANDS</td> </tr> <tr> <td>Postal Code:</td> <td>5656 AG</td> </tr> </table>		Name:	NXP B.V.	Street Address:	High Tech Campus 60	City:	Eindhoven	State/Country:	NETHERLANDS	Postal Code:	5656 AG								
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CORRESPONDENCE DATA																			
Fax Number:	(408)518-5671																		
Phone:	3474431592																		
Email:	david.schaeffer@nxp.com																		
<i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US Mail.</i>																			
Correspondent Name:	David L. Schaeffer																		
Address Line 1:	411 East Plumeria Drive, MS 41																		

CH \$320.00 7196409

Address Line 2: NXP Semiconductors, IP&L  
Address Line 4: San Jose, CALIFORNIA 95134

NAME OF SUBMITTER:

David L. Schaeffer

Total Attachments: 3

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**CONFIRMATORY ASSIGNMENT OF PATENT RIGHTS**

For valuable consideration, the receipt and sufficiency of this Confirmatory Assignment of Patent Rights (the "Assignment") which is hereby acknowledged, on this 26<sup>th</sup> day of March, 2012, Koninklijke Philips Electronics, N.V., a corporation, with a principal place of business at High Tech Campus 5, 5656 AE, Eindhoven, The Netherlands (and, previously, Groenewoudseweg 1, 5621 BA, Eindhoven, the Netherlands) ("Assignor"), to ensure that the assignment dated July 4, 2007, and filed with the United States Patent and Trademark Office on August 17, 2007, at Reel 019719, Frame 0843 (the "Original Assignment"), is completed, hereby sells, assigns, and transfers to NXP B.V., a corporation, having a principal place of business at High Tech Campus 60, Eindhoven, 5656 AG, the Netherlands ("Assignee"), the full extent of all right, title, and interest in and to any and all of the following (collectively, the "Rights"):

1. The patents, provisional patent applications and patent applications listed in the table below (individually and collectively referred to herein as the "Patents");
2. All inventions claimed or described in the Patents (collectively, the "Inventions");
3. All rights with respect to the Inventions, including all U.S. patents or other governmental grants or issuances that may be granted with respect to the Inventions or from any direct or indirect divisionals, continuations, continuations-in-part, or other patent applications claiming priority rights from the Patents ("Potential Patents");
4. All reissues, reexaminations, extensions, or registrations of the Patents or Potential Patents;
5. All non-United States patents, patent applications, and counterparts relating to any or all of the Inventions, the Patents, or Potential Patents, including, without limitation, certificates of invention, utility models, industrial design protection, design patent protection, and other governmental grants or issuances ("Foreign Rights"), and including the right to file foreign applications directly in the name of Assignee, its successors and assigns;
6. The right to claim priority rights deriving from the Patents;
7. All causes of action and remedies related to the Patents, the Inventions, Potential Patents, or Foreign Rights (including, without limitation, the right to sue for past, present, or future infringement, misappropriation or violation of rights related to any of the foregoing and the right to collect royalties and other payments under or on account of any of the foregoing); and
8. Any and all other rights and interests arising out of, in connection with, or in relation to, the Patents, the Inventions, Potential Patents, or Foreign Rights.

<b>Patent No.</b>	<b>Filing Date</b>	<b>Title of Patent and First Named Inventor</b>
U.S. 7,196,409	February 27, 2004	Semiconductor Device, Semiconductor Body and Method of Manufacturing Thereof  Josephus Adrianus Augustinus den Ouden
U.S. 7,733,657	July 26, 2005	Module Base Unit With Strain Relief Means  Reinhard Fritz, et al.
U.S. 7,413,108	August 7, 2003	Wedge-Bonding of Wires in Electronic Device Manufacture with Reversible Wedge Bonding Tool  Ramil N. Vasquez, et al.

Patent No.	Filing Date	Title of Patent and First Named Inventor
U.S. 7,750,436	July 7, 2005	Electronic Device Comprising an Integrated Circuit and a Capacitance Element Joop van Lammeren
U.S. 8,097,521	June 15, 2010	Electronic Device Comprising an Integrated Circuit and a Capacitance Element Joop van Lammeren
U.S. 7,340,872	November 25, 2002	Method of and Device for Packaging Electronic Components Thus Packaged Johannes Wilhelmus Dorotheus Bosch
U.S. 7,823,369	January 22, 2008	Device for Packaging an Electronic Component Johannes Wilhelmus Dorotheus Bosch
U.S. 7,545,026	July 6, 2005	Electronic Device Comprising an Integrated Circuit Jean-Claude G. Six

This Assignment is made fully effective on the date of the Original Assignment, thereby confirming the Assignor(s)'s intent to transfer all of the Rights as of that date.

Assignors will not sign any writing or do any act conflicting with this Assignment, and, without further compensation, will sign all documents and do such additional acts as Assignee, its successors, legal representatives, and assigns deem necessary or desirable to perfect enjoyment of the Rights, conduct proceedings regarding the Rights (including any litigation or interference proceedings), or perfect or defend title to the Rights. Assignors request the respective patent office or governmental agency in each jurisdiction to issue any and all patents, certificates of invention, utility models, or other governmental grants or issuances that may be granted upon any of the Rights in the name of the Assignee, as the assignee to the entire interest therein.

The terms and conditions of this Assignment will inure to the benefit of Assignee, its successors, legal representatives, and assigns and will be binding upon Assignors, their successors, legal representatives and assigns.

By: \_\_\_\_\_

Daan Dämen  
Authorized Representative  
Koninklijke Philips Electronics N.V.  
*(Signature MUST be attested)*

ATTESTATION OF SIGNATURE PURSUANT TO 28 U.S.C. § 1746

The undersigned witnessed the signature of Daan Damen to the above Confirmatory Assignment of Patent Rights on behalf of Koninklijke Philips Electronics N.V. and makes the following statements:

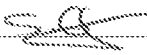
1. I am over the age of 18 and competent to testify as to the facts in this Attestation block if called upon to do so.

2. Daan Damen is personally known to me (or proved to me on the basis of satisfactory evidence) and appeared before me on 26 March, 2012 to execute the above Confirmatory Assignment of Patent Rights on behalf of Koninklijke Philips Electronics N.V.

3. Daan Damen subscribed to the above Confirmatory Assignment of Patent Rights on behalf of Koninklijke Philips Electronics N.V.

I declare under penalty of perjury under the laws of the United States of America that the statements made in the three (3) numbered paragraphs immediately above are true and correct.

EXECUTED on 26 03, 2012 (date)

  
Print Name: Simone Glas